

**To all Bondholders, Trustee and Principal Agent**

The Hongkong and Shanghai Banking Corporation Limited (the “Trustee” and “Principal Agent”)

Level 24, HSBC Main Building, 1 Queen’s Road Central, Hong Kong

Attention: Issuer Services

February 16, 2023

Dear Sirs

**REDEMPTION NOTICE AND NOTICE OF THE END OF THE CONVERSION PERIOD RELATING TO US\$300,000,000 ZERO COUPON CONVERTIBLE BONDS DUE 2024 (THE “BONDS”) ISSUED BY WUXI APPTEC CO., LTD.\* (無錫藥明康德新藥開發股份有限公司)**  
**(ISIN: XS2045749798, Common Code: 204574979)**

In accordance with Condition 7.2.1 of the terms and conditions of the Bonds (the “**Terms and Conditions**”), we hereby give notice to the Bondholders, the Trustee and the Principal of the early redemption of all outstanding Bonds at the Early Redemption Amount on April 4, 2023 (the “**Redemption Date**”). Further, we hereby confirm that the Early Redemption Amount as at the Redemption Date is U.S.\$104,519.38 for each U.S.\$100,000 principal amount of the Bonds. The end of the Conversion Period will be on March 21, 2023, therefore, the last date on which the Bondholders may exercise the conversion rights attaching to the Bonds shall be no later than 3:00 p.m. on March 20, 2023.

The Conversion Price as at the date of the relevant notice is HK\$66.17 per H Share. The aggregate principal amount of the Bonds outstanding as at the latest practicable date (i.e. February 15, 2023) prior to the date of this notice is U.S.\$71,600,000.

Capitalised terms used herein and not defined shall have the meanings given in the Terms and Conditions.

\* *For identification purposes only*

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For and on behalf of

**WuXi AppTec Co., Limited (無錫藥明康德新藥開發股份有限公司)**



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**Mr. Edward Hu**  
**Director**  
**Authorised Signatory**